DATA SHEET



MOS FIELD EFFECT TRANSISTOR

2SK2515

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2515 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

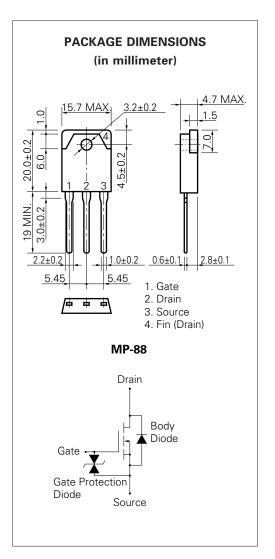
FEATURES

- Super Low On-Resistance
 - RDS (on)1 = 9 m Ω (VGS = 10 V, ID = 25 A)
 - RDS (on)2 = 14 $m\Omega$ (VGS = 4 V, ID = 25 A)
- Low Ciss Ciss = 3 400 pF TYP.
- · Built-in G-S Protection Diode

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	V_{DSS}	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID (DC)	±50	Α
Drain Current (pulse)*	ID (pul	se) ±200	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	150	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	3.0	W
Channel Temperature	T_ch	150	°C
Storage Temperature	T_{stg}	-55 to +150	°C

* PW \leq 10 μ s, Duty Cycle \leq 1 %



The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

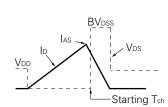


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

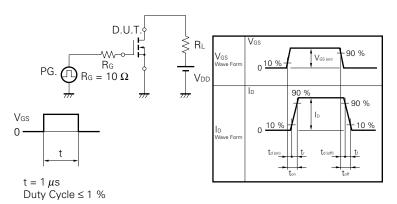
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)1		7.3	9.0	mΩ	Vgs = 10 V, ID = 25 A
Drain to Source On-Resistance	RDS (on)2		11	14	mΩ	Vgs = 4 V, ID = 25 A
Gate to Source Cutoff Voltage	VGS (off)	1.0	1.5	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l yfs l	20	58		S	V _{DS} = 10 V, I _D = 25 A
Drain Leakage Current	IDSS			10	μΑ	V _{DS} = V _{DSS} , V _{GS} = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		3 400		pF	V _{DS} = 10 V
Output Capacitance	Coss		1 600		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		770		pF	f = 1 MHz
Turn-On Delay Time	td (on)		55		ns	ID = 25 A
Rise Time	tr		360		ns	V _{GS(on)} = 10 V
Turn-Off Delay Time	td (off)		480		ns	V _{DD} = 30 V
Fall Time	tf		360		ns	$R_G = 10 \Omega$
Total Gate Charge	Q _G		152		nC	ID = 50 A
Gate to Source Charge	Qgs		11		nC	V _{DD} = 48 V
Gate to Drain Charge	Q _{GD}		60		nC	V _{GS} = 10 V
Body Diode Forward Voltage	VF (S-D)		0.92		V	IF = 50 A, VGS = 0
Reverse Recovery Time	trr		105		ns	IF = 50 A, VGS = 0
Reverse Recovery Charge	Qrr		265		nC	di/dt = 100 A/μs

Test Circuit 1 Avalanche Capability

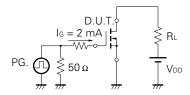
$R_{G} = 25 \Omega$ $V_{GS} = 20 \rightarrow 0 V$ V_{MM} D.U.T. S V_{DD} V_{DD}



Test Circuit 2 Switching Time

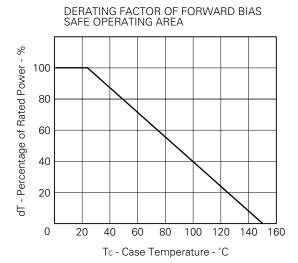


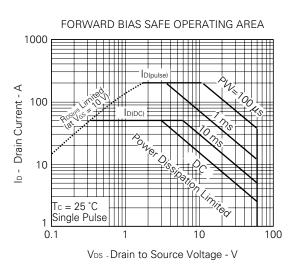
Test Circuit 3 Gate Charge

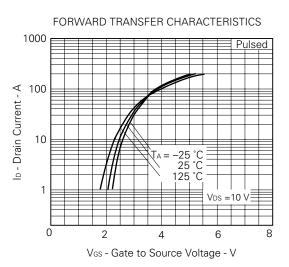


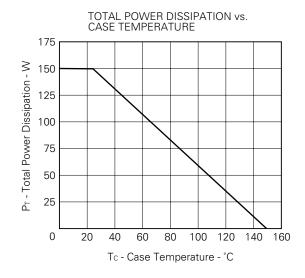
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

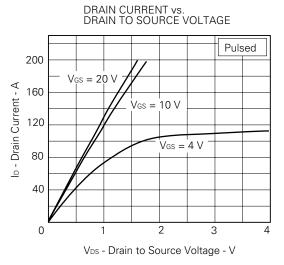
TYPICAL CHARACTERISTICS (TA = 25 °C)





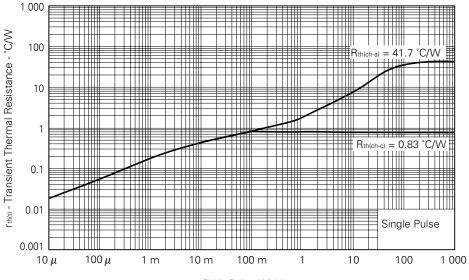






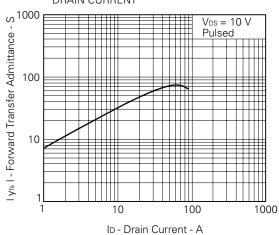


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

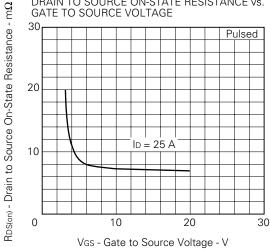


PW - Pulse Width - s

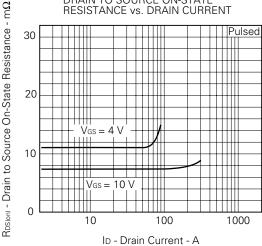




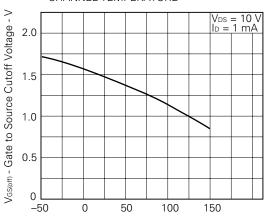
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



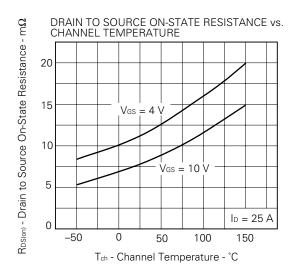
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

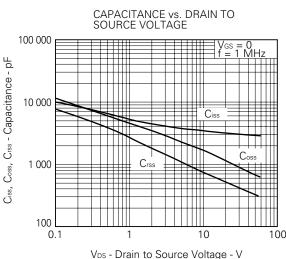


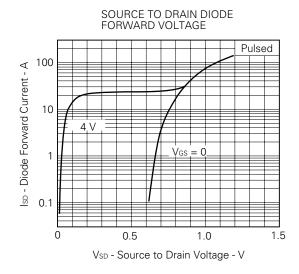
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

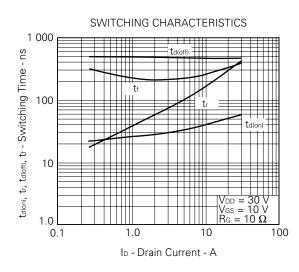


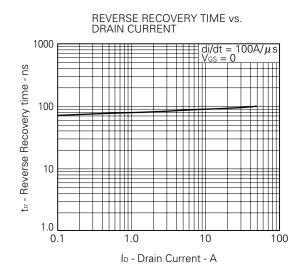
 T_{ch} - Channel Temperature - $^{\circ}C$

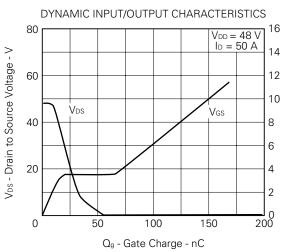




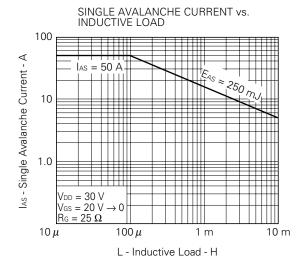


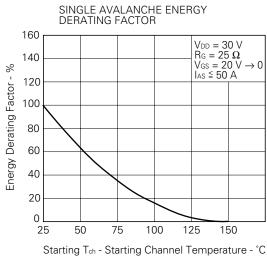














REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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